



110V Solderless High Power Cob Led 80W High Luminous Efficiency

Basic Information

- Place of Origin:
- Brand Name:
- Model Number: NE
- Minimum Order Quantity:
- Price:
- Packaging Details:
- Delivery Time:

Our Product Introduction

- Payment Terms:
- Supply Ability:
- NEW 5080 100pcs Negotiable Antistatic bag,boxes in carton. 3-5 workdays L/C, D/A, D/P, T/T, Western Union, MoneyGram 100000pcs/day

Shenzhen China

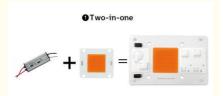
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Product Specification

- Voltage:
- Size:
- Luminous Surface Size:
- Luminous Flux:
- Chip Size:
- Luminous Angle:
- Highlight:

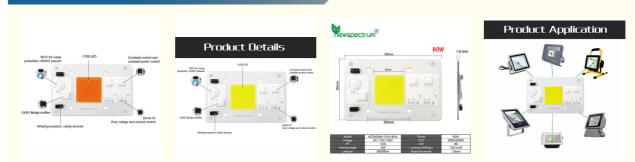
Solderless High Power Cob Led, 80W High Power Cob Led, High Luminous Efficiency High Power Cob







More Images



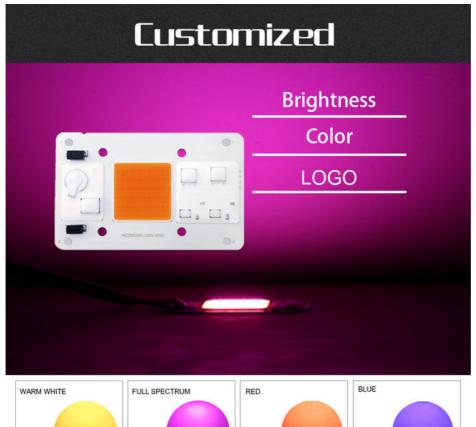
Product Description

model

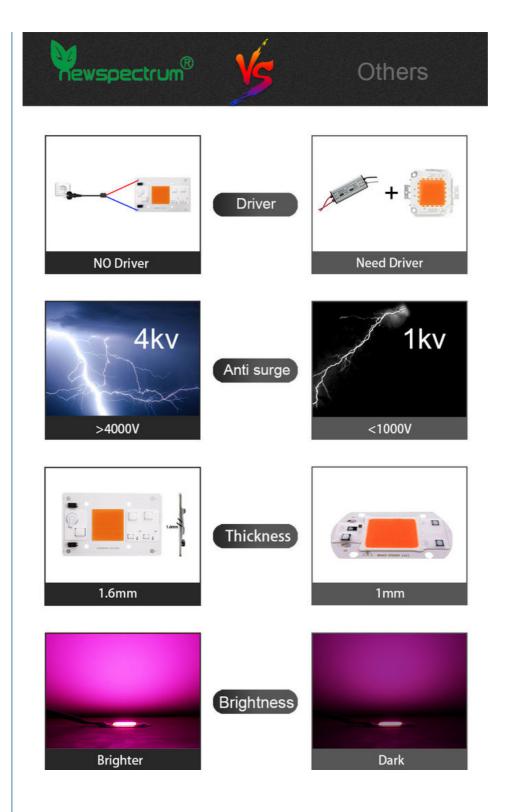
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110V solderless high-voltage non driving light source, 80W high luminous efficiency AC COB bead LED light source

HZZM5080-110V-80W Overall dimensions 50 * 80 (mm) Luminous surface size 25 * 25 (mm) power 80 (W) Color rendering index 70-80 Luminous flux 8000 (lm) Forward voltage 120 (V) Reverse voltage 120 (V) Electrostatic breakdown voltage (ESD) 2000 (V) Rated current 0.67 (A) Chip brand San An Chip size 2235 (mil) Fluorescent powder brand Internet Glue brand Shinyue, Japan Wire material nothing Substrate material Superconducting aluminum Luminous angle 120 ° luminous efficiency 100 (lm/W) Color tolerance 5 (SDCN) thermal resistance ≤ 10 (°/W) Maximum allowable junction temperature 120 ° Voltage temperature coefficient 60 (mV/° C) 1000 hours of routine aging 103% 6000 hours of routine aging 99% Did you pass the LM-80 test no Color temperature range 3000-6500 (K)





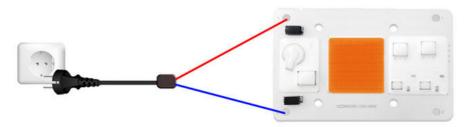


New Technology

1 Two-in-one



2 Smart IC integrated no driver



Led Flip Chip Assembly Technology

newspectrum®



Flip Chip

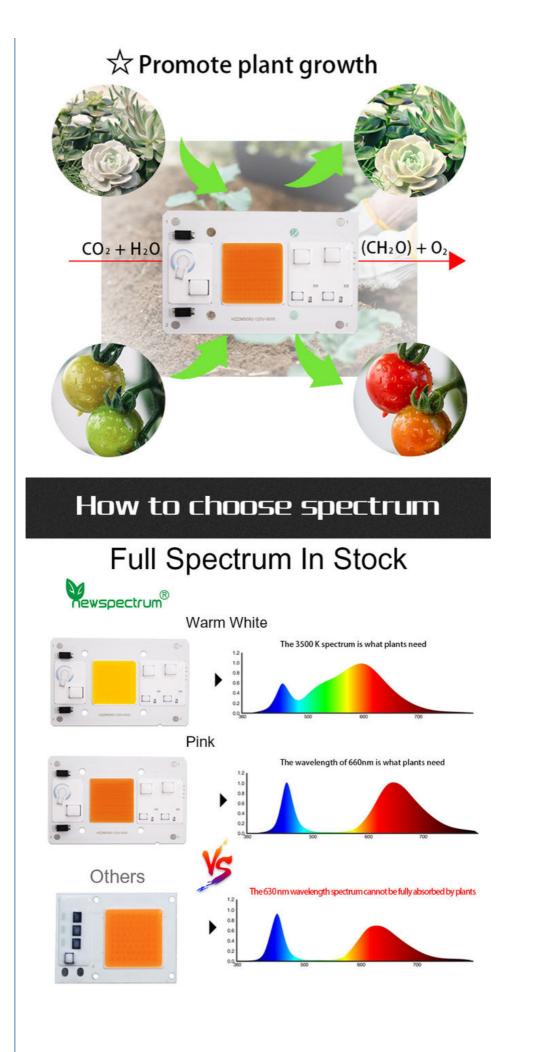
Wire Bonding Chip

A1:No lead connection required A2:No line shading, higher light output rate A3:Direct bonding, good heat dissipation effect A4:Suitable for high-power light sources A5:Longer life A1:Need lead connection A2:The front electrode blocks light, and the light output rate is low A3:Insulating glue solid crystal, low heat dissipation efficiency A4:Only suitable for small current A5:Wired occupies volume, small space

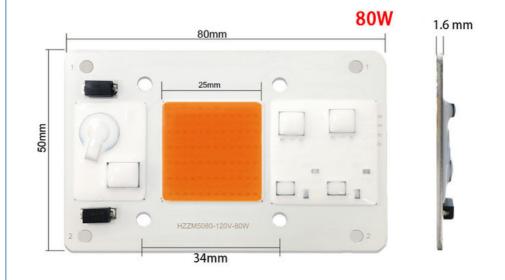
Others Wire Bonding Chip

Application Scenarios









Model	HZZM5080-120V-80W	Power	80W
Voltage	AC 110V-130V	ССТ	1400K
PF	>0.9	CRI	80
Viewing angle	120°	Luminous Efficacy	100 lm/W
Lifespan	50000hrs	Board thickness	1.6mm

Product Details



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